

Micro Commercial Components



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2N7002K

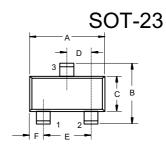
Features

- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1 High density cell design for low RDS(ON)
- Voltage controlled small signal switch
- Rugged and reliable
- High saturation current capability
- Marking: 72K
- ESD Protected up to 2KV (HBM)

Maximum Ratings @ 25°C Unless Otherwise Specified

Symbol	Rating	Rating	Unit	
V_{DS}	Drain-source Voltage	60	V	
V_{GS}	Gate-source Voltage	±20	V	
I _D	Drain Current	340	mA	
P_D	Total Power Dissipation	350	mW	
TJ	Operating Junction Temperature	-55 to +150	$^{\circ}\mathbb{C}$	
T _{STG}	Storage Temperature	-55 to +150	$^{\circ}\mathbb{C}$	
RthJA	Thermal Resistance fromJunction to Ambient	357	%C\M	

N-Channel MOSFET



1.GATE

- 2. SOURCE
- 3. DRAIN

Electrical Characteristics @ 25°C Unless Otherwise Specified

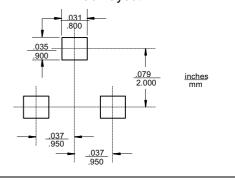
Symbol	Parameter			Тур	Max	Units
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage (V _{GS} =0Vdc, I _D =10µAdc)					Vdc
$V_{GS(th)}$	Gate-Threshold Voltage (V _{DS} =V _{GS} , I _D =1mAdc)		1.0			Vdc
I _{GSS}				-	±200 ±100	nAdc nAdc
I _{DSS}	Zero Gate Voltage Drain Current (V _{DS} =48Vdc, V _{GS} =0Vdc)			-	1	uAdc
r _{DS(on)}	Drain-Source On-Resistance (V _{GS} =4.5Vdc, I _D =200mAdc) (V _{GS} =10Vdc, I _D =500mAdc)				5.3 5.0	Ω
V _{SD}	Diode Forward Voltage (V _{GS} =0Vdc, I _S =300mAdc)				1.5	Vdc
Qr	Recovered charge (Vgs=0V, Is=300mA,VR=25V,) (dI _s /dt=-100A/µS)		-	30		nC
C _{iss}	Input Capacitance	\/ _10\/do			40	
Coss	Output Capacitance	V_{DS} =10Vdc, V_{GS} =0Vdc			30	pF
C _{rSS}	Reverse Transfer Capacitance	f=1MHz			10	ρι

Switching

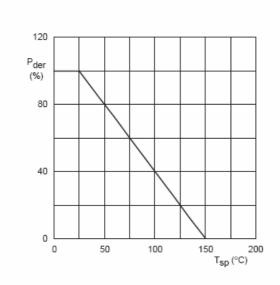
omitoning						
t _{d(on)}	Turn-on Time	V_{DD} =50 V, R_L =250 Ω , R_{GS} =50 Ω , V_{GS} =10 V,			10	
t _{d(off)}	Turn-off Time	$R_G=50\Omega$			15	ns
t _{rr}	Reverse recovery time	$V_{GS}=0V$, $I_{S}=300$ mA, $V_{R}=25V$, $I_{S}=100$ m/ $I_{S}=1000$ m/ $I_{S}=10000$ m/ $I_{S}=10000$ m/ $I_{S}=10000$ m/ $I_{S}=10000$ m/ $I_{S}=10000$ m/ $I_{S}=100000$ m/ $I_{S}=100$		30	ł	113

DIMENSIONS						
	INCHES		MM			
DIM	MIN	MAX	MIN	MAX	NOTE	
Α	.110	.120	2.80	3.04		
В	.083	.104	2.10	2.64		
С	.047	.055	1.20	1.40		
D	.035	.041	.89	1.03		
Е	.070	.081	1.78	2.05		
F	.018	.024	.45	.60		
G	.0005	.0039	.013	.100		
Н	.035	.044	.89	1.12		
J	.003	.007	.085	.180		
K	015	020	37	51		

Suggested Solder Pad Layout

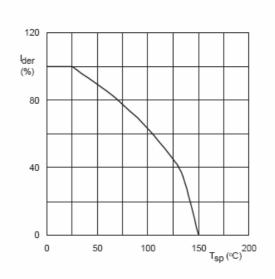






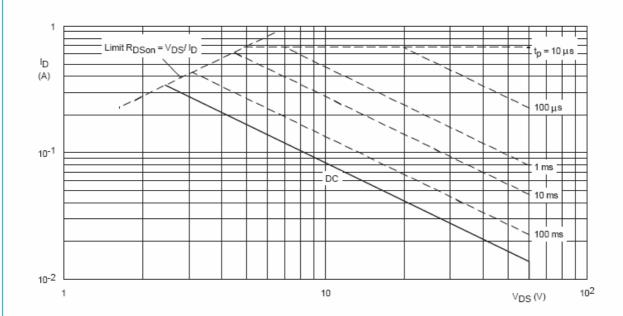
$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

Fig 1. Normalized total power dissipation as a function of solder point temperature.



$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100\%$$

Fig 2. Normalized continuous drain current as a function of solder point temperature.

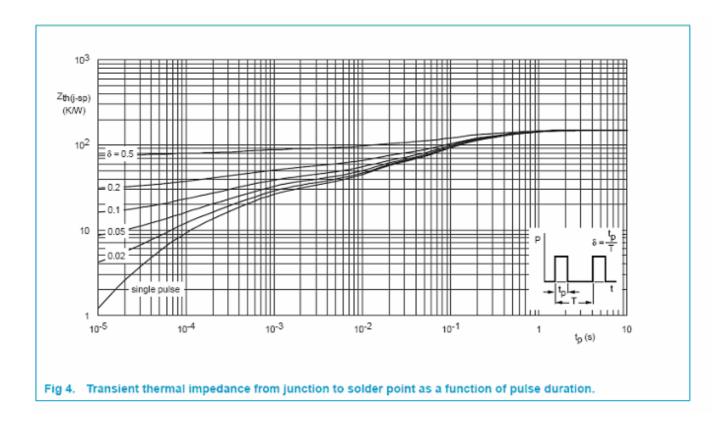


 T_{sp} = 25 °C; I_{DM} is single pulse; V_{GS} = 10 V

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage.

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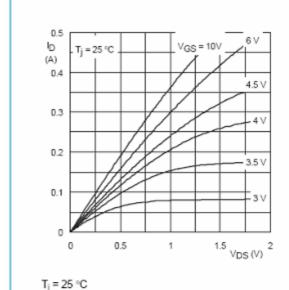
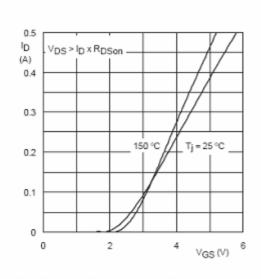


Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values.



 $T_j = 25 \,^{\circ}\text{C}$ and 150 $^{\circ}\text{C}$; $V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values.

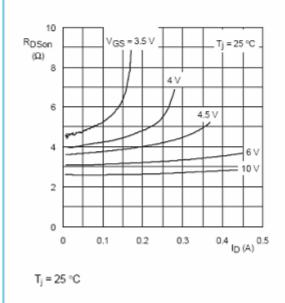
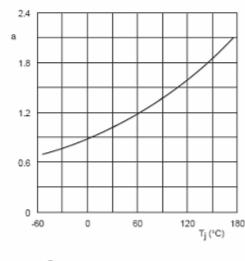


Fig 7. Drain-source on-state resistance as a function of drain current; typical values.



 $a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$

Fig 8. Normalized drain-source on-state resistance factor as a function of junction temperature.



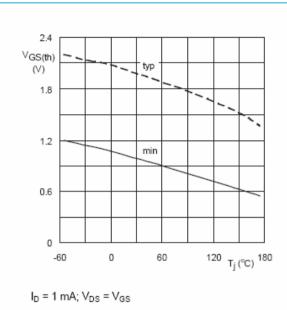
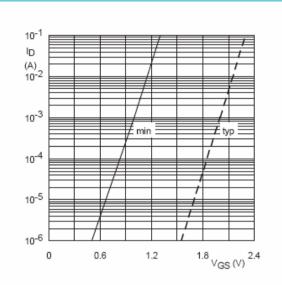
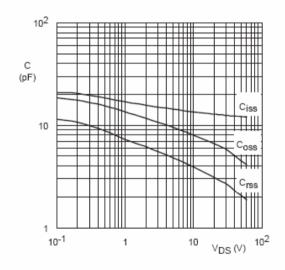


Fig 9. Gate-source threshold voltage as a function of junction temperature.



 $T_j = 25 \,^{\circ}\text{C}; \, V_{DS} = 5 \,^{\circ}\text{V}$

Fig 10. Sub-threshold drain current as a function of gate-source voltage.



 V_{GS} = 0 V; f = 1 MHz

Fig 11. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values.



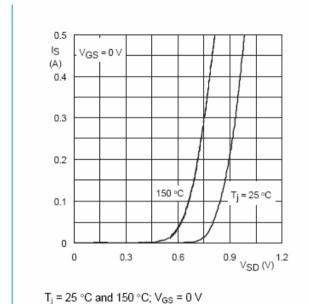
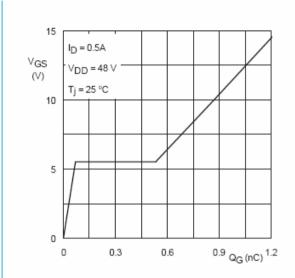


Fig 12. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values



I_D = 0.5 A; V_{DD} = 48 V

Fig 13. Gate-source voltage as a function of gate charge; typical values.



Ordering Information:

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

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